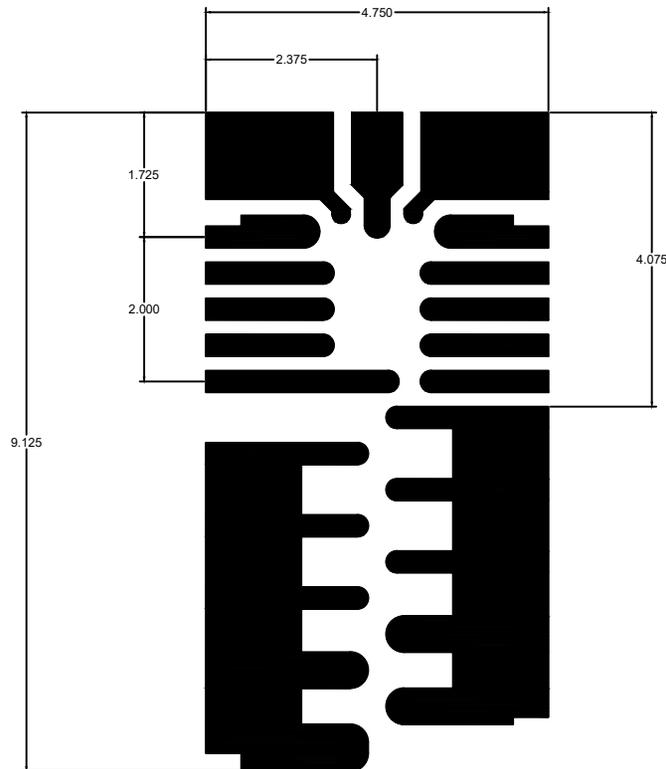
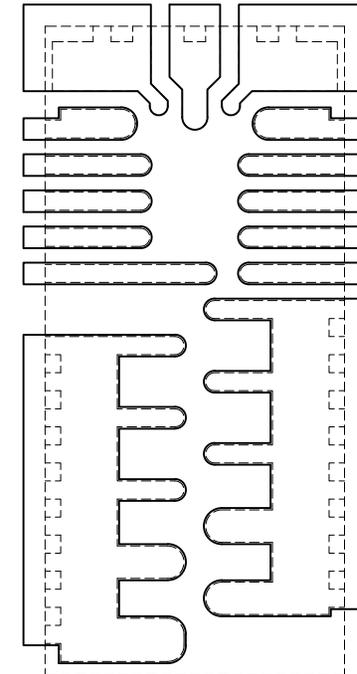


RECOMMENDED LAND PATTERN



PACKAGE OVERLAY



NOTES:

1. PADS TO EXTEND 0.30MM BEYOND COMPONENT EDGE.
2. REFERENCE PKG. OUTLINE: 21-100027
3. TOLERANCE: +/- 0.02 MM.
4. ALL DIMENSIONS APPLY TO BOTH LEADED (-) AND PbFREE (+) PKG. CODES.
5. ALL DIMENSIONS IN MM.
6. REFER TO APPLICATION NOTES 5963 FOR SMT STENCIL DESIGN RECOMMENDATIONS

—DRAWING NOT TO SCALE—



This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depends on many factors unknown to Maxim (eg. user's board manufacturing specs), user must determine suitability for use. This document is subject to change without notice. Contact technical support at <http://www.maxim-ic.com/support> for further questions.

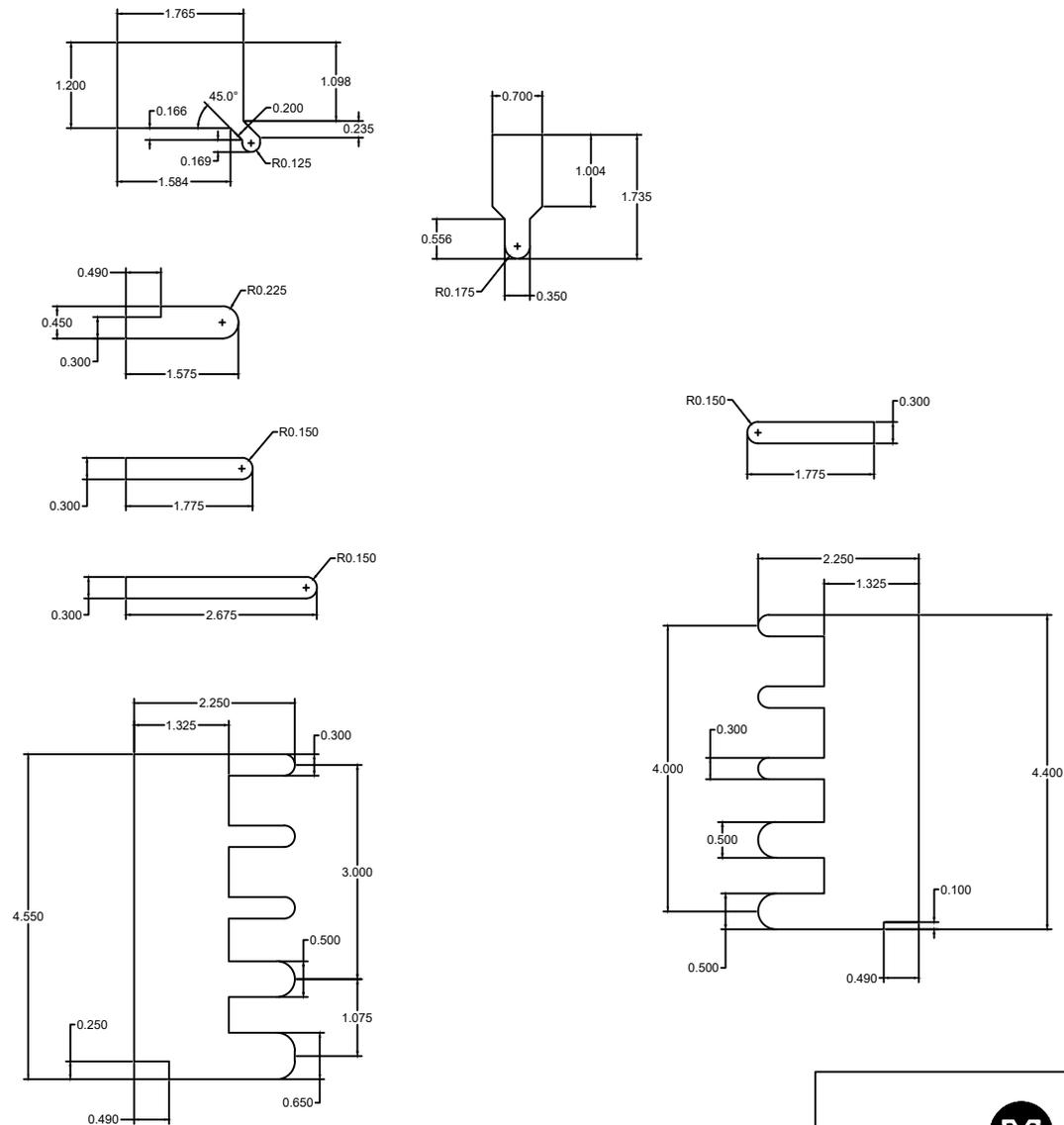
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PACKAGE LAND PATTERN,
[P154A9F-1] FCQFN

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PAD DETAILS



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